

(News Release / Translation)

March 2, 2026

Name of company	V-Technology Co., Ltd.
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Announcement Regarding the Establishment of the “Advanced Packaging Business Promotion Headquarters”

**– Integration of Group Organizations to Address Expanding Demand for Semiconductor
Package DI Exposure Systems –**

1. Purpose of Establishment

In May 2024, the Group formulated its Medium-Term Management Plan. To achieve the targets for the fiscal year ending March 2028, the Company has decided to establish a new organization to further strengthen its Advanced Packaging business, which is positioned as a key growth area.

Previously, LE-TECHNOLOGY (DI exposure systems), OHT (O/S testers), and JAC (wet process equipment) have collaborated with V Technology Co., Ltd. to promote the business. CMP equipment is also currently under development.

In response to the rapidly expanding demand in the semiconductor packaging market, the Company believes that integrating its group organizations under a unified structure will enable more efficient utilization of management resources and faster response to customer needs.

2. New Organizational Structure (Effective March 1, 2026)

